

SilGrip* PSA6574 Pressure Sensitive Adhesive

SilGrip* PSA6574 Pressure Sensitive Adhesive

Description

PSA6574 silicone pressure sensitive adhesive is a toluene solution of phenyl based polysiloxane gum and resin. It is supplied at 55 percent silicone solids and may be further diluted with aromatic, aliphatic or chlorinated solvents. PSA6574 may be blended with SR545 resin dispersion to obtain specific performance properties. PSA6574 adhesive has been found useful in coating of film and fabric substrates for manufacturing industrial pressure sensitive tapes, label stock for extremely high and low temperature applications and transfer tapes. It may be an excellent choice for tapes used in plasma/flame spray applications due to its superior thermal stability.

Key Features and Benefits

- Wide temperature range performance, maintains good shear and tack properties at intermittent temperatures up to 500°F
- Adhesion to a wide variety of surfaces including low energy surfaces (silicones, fluoropolymers, polyolefines)
- Resistance to moisture, weathering (ozone, sunlight), chemical (acids, alkalis, oils) and biological (fungus) attack
- Minimum silicone residue on applied surfaces

Typical Physical Properties

Property	Value
Silicone Solids, %	55

Specific Gravity	0.98
Density, lbs/gal	8.3
Viscosity @ 25° (77°F), cps (Brookfield RVF, #5 spindle, 4 rpm)	17,000
Color	Light Straw
Flash Point, PMCC, ° C (° F)	11 (52)
Solvent	Toluene, VM& P Naphtha

TYPICAL CURED ADHESIVE PROPERTIES

• Peel Adhesion ⁽¹⁾ , g/inch	2700
• Tack ⁽²⁾ , g/cm ²	1420

(1) 2 mil dry adhesive thickness, 1mil polyester film, uncatalyzed, curing cycle: 10 min air dry, 90 sec at 177°C

(2) Polyken Tack Tester, 1000g weight, 1sec dwell time, 1 cm/sec draw speed, 2 mil dry adhesive thickness, 1mil polyester film, uncatalyzed, curing cycle: 10 min air dry, 90 sec at 177°C

The properties of a cured silicone adhesive are affected by several factors such as type and amount of catalyst, cure cycle, adhesive thickness and backing type and thickness. Higher benzoyl peroxide catalyst concentration will increase cohesive strength of the adhesive and improve shear strength, but it will reduce its adhesive strength resulting in lower tack and peel values.

Patent Status

Standard copy to come

Product Safety, Handling and Storage

The warranty period is 6 months from date of shipment from Momentive Performance Materials if stored in the original unopened container at 25°C (77°F).

Standard copy to come

Processing Recommendations

Application

PSA6574 silicone adhesive is supplied at a viscosity suitable for conventional tape coating equipment. If necessary, it may be thinned with toluene, xylene or other compatible solvents. After the adhesive is applied to the backing, it is exposed to a two step process: solvent removal and curing.

Solvent Removal

To achieve optimum adhesive properties, it is essential to optimize the drying step of the process in order to assure that the solvent is removed from the adhesive film before the curing step of the process starts. Improper drying will result in residual solvent entrapment within the adhesive. If the adhesive is then exposed to temperatures higher than 93.5 ° C (200 ° F), decomposing peroxide catalyst can cause crosslinking reaction between solvent and adhesive through methyl groups on siloxane chains and on solvent molecules and adversely affect the properties of the adhesive. Typical temperature range for the drying step of the process is 83 ° C (180 ° F) to 90 ° C (194 ° F). A typical drying cycle is 2 minutes at 90 ° C (194 ° F).

Curing Process

Once the solvent is removed from the adhesive film, the peroxide cure should be initiated by exposure to heat. A typical curing cycle is 2 minutes at 165 ° C (329 ° F). Longer exposure time and higher temperature, up to 204 ° C (400 ° F), can be used without adverse effects. The exact conditions required to achieve a complete cure will depend on oven length and efficiency, peroxide type and type of substrate used, and should be established during experimental trials on the machine.

Catalysts

High purity, 98% benzoyl peroxide ⁽³⁾ in the quantity of 1 to 3% based on silicone solids, has been found to give the most consistent results in curing of silicone pressure sensitive adhesives. In applications requiring low temperature cure, 2,4-dichlorobenzoyl peroxide, which is activated at 132 ° C (270 ° F), can be used. It should be noted that 2,4-dichlorobenzoyl peroxide may generate polychlorinated biphenyls during the curing process. Please refer to Code of Federal Regulations, title 40, part 761 regarding incidental PCB byproducts if 2,4- dichlorobenzoyl peroxide is utilized.

The peroxide should be dispersed in solvent before it is mixed with the adhesive. Thorough mixing of the peroxide and adhesive to achieve homogeneous dispersion is essential for consistency of finished product.

(3) Available from: Elf Atochem North America, Inc.,

Priming

In certain applications, the anchorage of the adhesive to the backing may be insufficient and the coating of a primer prior to the adhesive coating may be required.

A typical formulation for a primer may be found in Table1 below. The formulation may need to be adjusted depending on required bath life, coating equipment and backing material. The primer may be coated by direct gravure, wire wound rod or other coating technique suitable for solvent based coatings, and must be cured prior to adhesive application. The curing conditions will depend on equipment capabilities, substrate type and formulation used and should be established during experimental trials on the machine.

Table1. Typical Primer ⁽⁴⁾ Formulation

Component	Parts by Weight
SS4195A-D1	13.3
SS4191B	0.3
SS4192c	0.5
SS4259c	0.5
Solvent ⁽⁵⁾	85.4

(4) Refer to document #CDS5511, SS4195-D1 Primer for Phenyl Based Silicone Pressure Sensitive Adhesives, for more information

(5) Typical solvents: toluene, heptane, toluene/heptane mixtures

Limitations

Standard copy to come

Contact Information

For product prices, availability, or order placement, contact our customer service at Momentive.com/CustomerService/

For literature and technical assistance, visit our website at: www.momentive.com

DISCLAIMER:

THE MATERIALS, PRODUCTS AND SERVICES OF MOMENTIVE PERFORMANCE MATERIALS INC. AND ITS SUBSIDIARIES AND AFFILIATES (COLLECTIVELY "SUPPLIER"), ARE SOLD SUBJECT TO SUPPLIER'S STANDARD CONDITIONS OF SALE, WHICH ARE INCLUDED IN THE APPLICABLE DISTRIBUTOR OR OTHER SALES AGREEMENT, PRINTED ON THE BACK OF ORDER ACKNOWLEDGMENTS AND INVOICES, AND AVAILABLE UPON REQUEST. ALTHOUGH ANY INFORMATION, RECOMMENDATIONS, OR ADVICE CONTAINED HEREIN IS GIVEN IN GOOD FAITH, SUPPLIER MAKES NO WARRANTY OR GUARANTEE, EXPRESS OR IMPLIED, (i) THAT THE RESULTS DESCRIBED HEREIN WILL BE OBTAINED UNDER END-USE CONDITIONS, OR (ii) AS TO THE

EFFECTIVENESS OR SAFETY OF ANY DESIGN INCORPORATING ITS PRODUCTS, MATERIALS, SERVICES, RECOMMENDATIONS OR ADVICE. EXCEPT AS PROVIDED IN SUPPLIER'S STANDARD CONDITIONS OF SALE, SUPPLIER AND ITS REPRESENTATIVES SHALL IN NO EVENT BE RESPONSIBLE FOR ANY LOSS RESULTING FROM ANY USE OF ITS MATERIALS, PRODUCTS OR SERVICES DESCRIBED HEREIN. Each user bears full responsibility for making its own determination as to the suitability of Supplier's materials, services, recommendations, or advice for its own particular use. Each user must identify and perform all tests and analyses necessary to assure that its finished parts incorporating Supplier's products, materials, or services will be safe and suitable for use under end-use conditions. Nothing in this or any other document, nor any oral recommendation or advice, shall be deemed to alter, vary, supersede, or waive any provision of Supplier's standard Conditions of Sale or this Disclaimer, unless any such modification is specifically agreed to in a writing signed by Supplier. No statement contained herein concerning a possible or suggested use of any material, product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right of Supplier covering such use or design, or as a recommendation for the use of such material, product, service or design in the infringement of any patent or other intellectual property right.

*SilGrip is a trademark of Momentive Performance Materials Inc.

Momentive and the Momentive logo are trademarks of Momentive Performance Materials Inc.